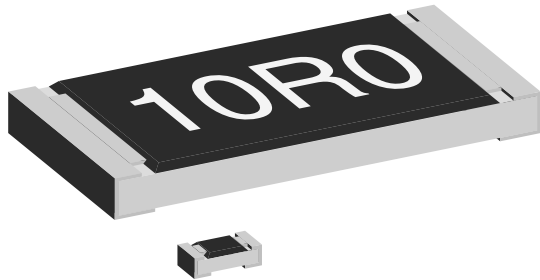


Lead (Pb)-free Thick Film, Rectangular, Pulse Proof Chip Resistors



FEATURES

- High pulse performance
- Metal glaze on high quality ceramic
- Protective overglaze
- Lead (Pb)-free solder contacts on Ni barrier layer
- Pure tin plating provides compatibility with lead (Pb)-free and lead containing soldering processes
- Compatible with "Restriction of the use of Hazardous Substances" (RoHS) directive 2002/95/EC (issue 2004)
- Excellent stability ($\Delta R/R \leq \pm 1\%$ for 1000 h at 70 °C) in different environmental conditions



STANDARD ELECTRICAL SPECIFICATIONS

MODEL	SIZE		POWER RATING $P_{70}^{\circ\text{C}}$ W	LIMITING ELEMENT VOLTAGE MAX. V	TEMPERATURE COEFFICIENT ppm/K	TOLERANCE %	RESISTANCE RANGE Ω	E-SERIES
	INCH	METRIC						
D10/CRCW0402-IF	0402	1005	0.063	50	± 200	$\pm 5, \pm 10$	1R0 - 100K	E24
D11/CRCW0603-IF	0603	1608	0.10	75	± 200	$\pm 5, \pm 10$	1R0 - 100K	E24
D12/CRCW0805-IF	0805	2012	0.125	150	± 200	$\pm 5, \pm 10$	1R0 - 100K	E24
D25/CRCW1206-IF	1206	3216	0.25	200	± 200	$\pm 5, \pm 10$	1R0 - 100K	E24

Notes

- These resistors do not feature a limited lifetime when operated within the permissible limits. However, resistance value drift increasing over operating time may result in exceeding a limit acceptable to the specific application, thereby establishing a functional lifetime.
- Marking and packaging: See appropriate catalog or web pages
- Power rating depends on the max. temperature at the solder point, the component placement density and the substrate material

TECHNICAL SPECIFICATIONS

PARAMETER	UNIT	D10/CRCW0402-IF	D11/CRCW0603-IF	D12/CRCW0805-IF	D25/CRCW1206-IF
Rated Dissipation at $P_{70}^{(1)}$	W	0.063	0.10	0.125	0.25
Limiting Element Voltage U_{max} AC/DC	V	50	75	150	200
Insulation Voltage U_{ins} (1 min)	V	> 75	> 100	> 200	> 300
Thermal Resistance	K/W	≤ 870	≤ 550	≤ 440	≤ 220
Insulation Resistance	Ω	$> 10^9$			
Category Temperature Range	$^{\circ}\text{C}$	- 55 to + 155			
Weight	mg	0.65	2	5.5	10

Note

- ⁽¹⁾ The power dissipation on the resistor generates a temperature rise against the local ambient, depending on the heat flow support of the printed-circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature of 155 °C is not exceeded.

PART NUMBER AND PRODUCT DESCRIPTION

PART NUMBER: CRCW08051R00JNEAIF⁽²⁾

C R C W 0 8 0 5 1 R 0 0 J N E A I F

MODEL/SIZE	VALUE	TOLERANCE	TCR	PACKAGING ⁽³⁾	SPECIAL
CRCW0402 CRCW0603 CRCW0805 CRCW1206	R = Decimal K = Thousand	J = $\pm 5\%$ K = $\pm 10\%$	N = ± 200 ppm/K S = Special	EA, EB, EC ED, EE, EI, EL	Up to 2 digits IF = Pulse

PRODUCT DESCRIPTION: D12/CRCW0805-IF 200 1R0 5 % ET1 e3

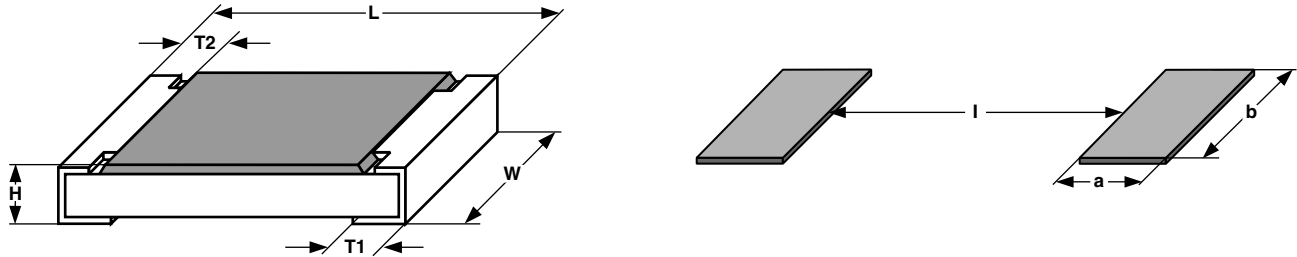
D12/CRCW0805-IF	200	1R0	5 %	ET1	e3
MODEL	TCR	RESISTANCE VALUE	TOLERANCE	PACKAGING ⁽³⁾	LEAD (Pb)-FREE
D10/CRCW0402-IF D11/CRCW0603-IF D12/CRCW0805-IF D12/CRCW1206-IF	± 200 ppm/K	1R0 = 1 Ω 10K = 10.0 k Ω	$\pm 5\%$ $\pm 10\%$	ET1, ET5, ET6, ET7, EF4, EG1, E20	e3 = Pure tin Terminal finish

Notes

- ⁽²⁾ Preferred way for ordering products is by use of the PART NUMBER
⁽³⁾ Please refer to table PACKAGING, see next page

PACKAGING

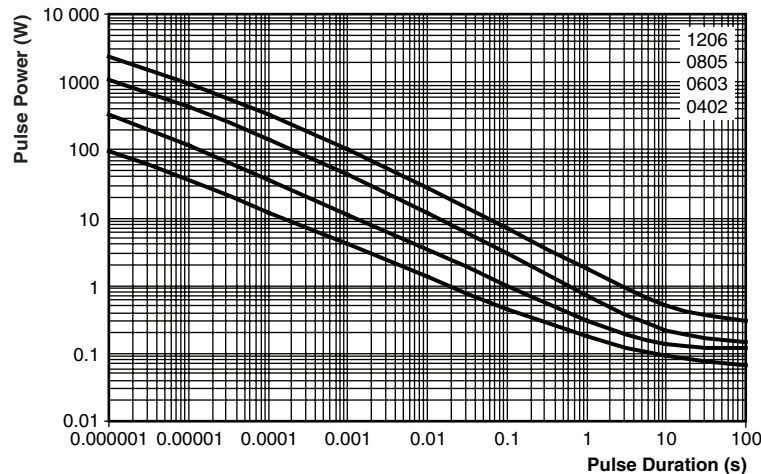
MODEL	TAPE WIDTH	DIAMETER	PITCH	PIECES/ REEL	PACKING CODE			
					PART NUMBER		PRODUCT DESC.	
					PAPER	BLISTER	PAPER	BLISTER
D10/CRCW0402-IF	8 mm	180 mm/7"	2 mm	10 000	ED		ET7	
		330 mm/13"	2 mm	50 000	EE		EF4	
D11/CRCW0603-IF	8 mm	180 mm/7"	4 mm	5000	EA	EI	ET1	EG1
		285 mm/11.25"	4 mm	10 000	EB		ET5	
		330 mm/13"	4 mm	20 000	EC	EL	ET6	E20
D12/CRCW0805-IF	8 mm	180 mm/7"	4 mm	5000	EA	EI	ET1	EG1
		285 mm/11.25"	4 mm	10 000	EB		ET5	
		330 mm/13"	4 mm	20 000	EC	EL	ET6	E20
D25/CRCW1206-IF	8 mm	180 mm/7"	4 mm	5000	EA	EI	ET1	EG1
		285 mm/11.25"	4 mm	10 000	EB		ET5	
		330 mm/13"	4 mm	15 000		EL		E20
		330 mm/13"	4 mm	20 000	EC		ET6	

DIMENSIONS


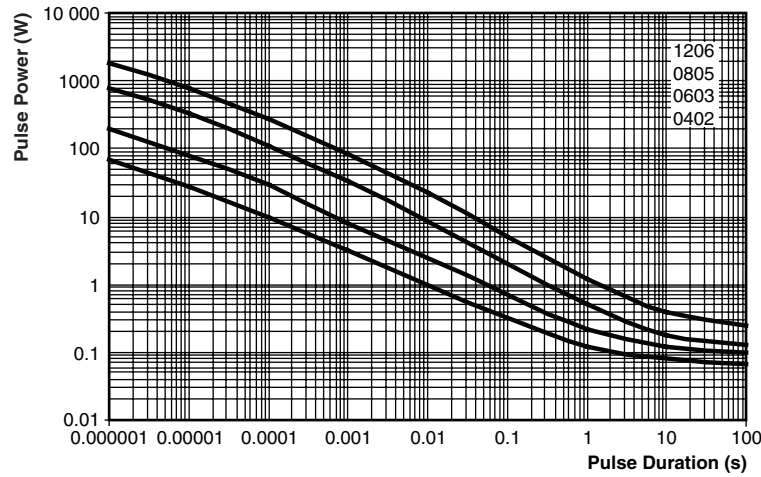
SIZE		DIMENSIONS (in millimeters)					SOLDER PAD DIMENSIONS (in millimeters)					
INCH	METRIC	L	W	H	T1	T2	REFLOW SOLDERING			WAVE SOLDERING		
0402	1005	1.0 ± 0.05	0.5 ± 0.05	0.35 ± 0.05	0.25 ± 0.05	0.2 ± 0.1	a	b	l	a	b	l
0603	1608	1.55 ^{+0.10} _{-0.05}	0.85 ± 0.1	0.45 ± 0.05	0.3 ± 0.2	0.3 ± 0.2	0.5	0.9	1.0	0.9	0.9	1.0
0805	2012	2.0 ^{+0.10} _{-0.20}	1.25 ± 0.15	0.45 ± 0.05	0.3 ± 0.2	0.3 ± 0.2	0.7	1.3	1.2	0.9	1.3	1.3
1206	3216	3.2 ^{+0.10} _{-0.20}	1.6 ± 0.15	0.55 ± 0.05	0.45 ± 0.2	0.4 ± 0.2	0.9	1.7	2.0	1.1	1.7	2.3

FUNCTIONAL PERFORMANCE

Maximum pulse dissipation as a function of the pulse duration, single pulse

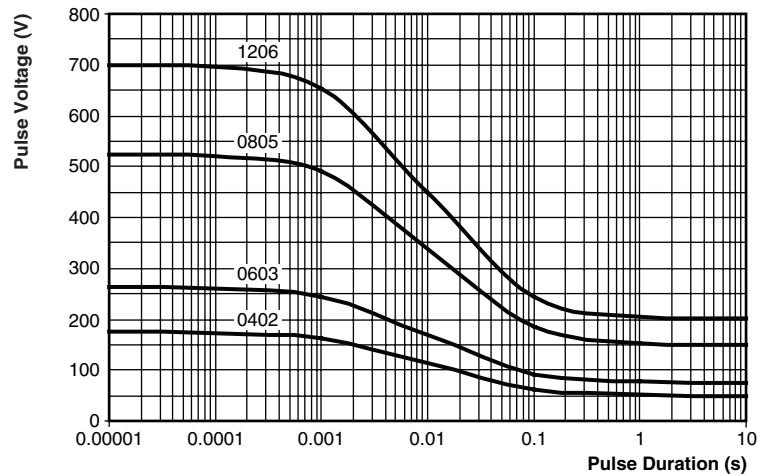

Maximum pulse load, single pulse; applicable if $\bar{P} \rightarrow 0$ and $n \leq 1000$ and $\dot{U} \leq \dot{U}_{max}$; for permissible resistance change equivalent to 8000 h operation

Maximum pulse dissipation as a function of the pulse duration, continuous pulse

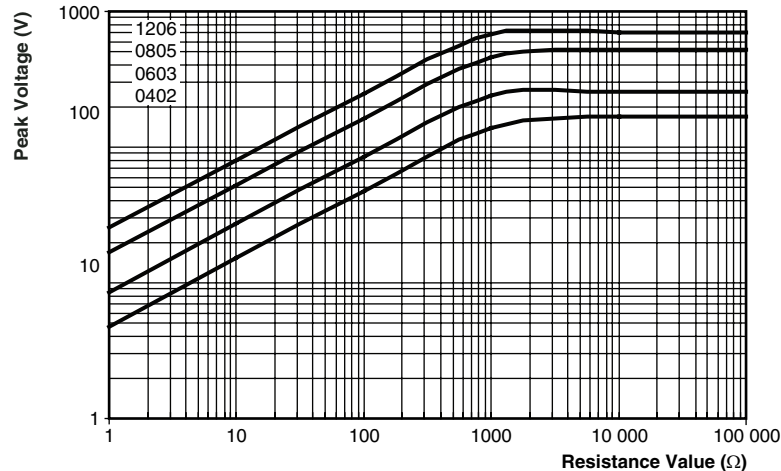


Maximum pulse load, continuous pulses; applicable if $\bar{P} \leq P(\vartheta_{amb})$ and $\bar{U} \leq \bar{U}_{max}$;
for permissible resistance change equivalent to 8000 h operation

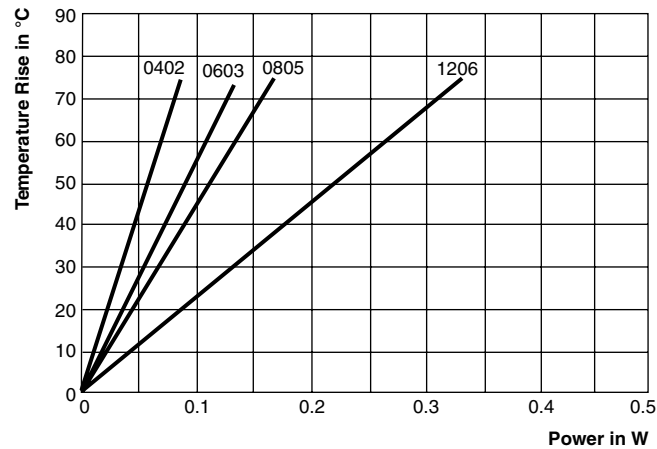
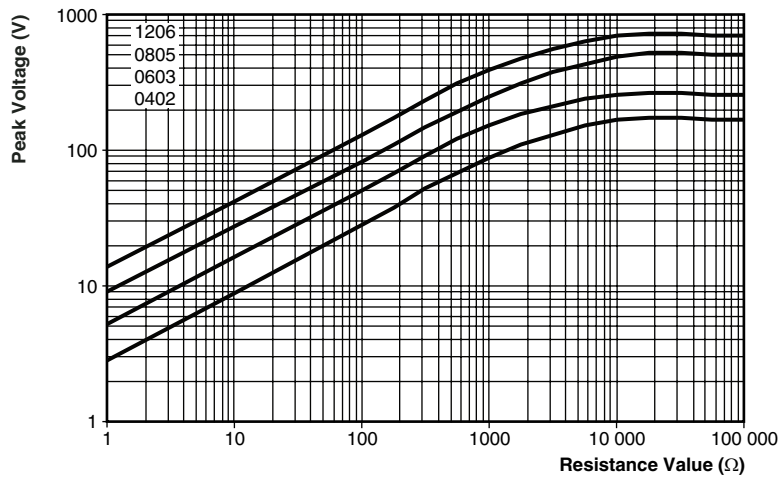
Maximum permissible pulse voltage as a function of pulse duration



Maximum pulse voltage, single and continuous pulses; applicable if
 $\hat{P} \leq \hat{P}_{max}$; for permissible resistance change equivalent to 8000 h operation

Single-pulse high voltage overload test 1.2/50 μ s EN140000 4.27

Pulse load rating in accordance to EN 60115-1, 4.27; 1.2 μ s/50 μ s;
5 pulses at 12 s intervals; for permissible resistance change 1 %

Single-pulse high voltage overload test 10/700 μ s EN140000 4.27

Temperature Rise

TEST PROCEDURES AND REQUIREMENTS

EN 60115-1			
TEST (clause)	CONDITIONS OF TEST	REQUIREMENTS PERMISSIBLE CHANGE ($\Delta R/R$)	
		STABILITY CLASS 1 OR BETTER	
	Stability for product types:		
	D../CRCW....-IF e3	1 Ω to 100 k Ω	
Resistance (4.5)	-	$\pm 5 \%$	$\pm 10 \%$
Temperature coefficient (4.8.4.2)	20/- 55/20 $^{\circ}\text{C}$ and 20/125/20 $^{\circ}\text{C}$	± 200 ppm/K	
Overload (4.13)	$U = 2.5 \times (P_{70} \times R)^{1/2}$ $\leq 2 \times U_{\text{max.}}$; Duration: according the style	$\pm (0.25 \% R + 0.05 \Omega)$	
Solderability (4.17.5)	Aging 4 h at 155 $^{\circ}\text{C}$, dryheat solder bath method; 235 $^{\circ}\text{C}$; 2 s visual examination	Good tinning ($\geq 95 \%$ covered) no visible damage	
Resistance to soldering heat (4.18.2)	Solder bath method; (260 ± 5) $^{\circ}\text{C}$; (10 ± 1) s	$\pm (0.25 \% R + 0.05 \Omega)$	
Rapid change of temperature (4.19)	30 min at LCT = - 55 $^{\circ}\text{C}$; 30 min at UCT = 125 $^{\circ}\text{C}$; 5 cycles	$\pm (0.25 \% R + 0.05 \Omega)$	
Damp heat, steady state (4.24)	(40 ± 2) $^{\circ}\text{C}$; 56 days; (93 ± 3) % RH	$\pm (1 \% R + 0.05 \Omega)$	
Climatic sequence (4.23)	16 h at UCT = 125 $^{\circ}\text{C}$; 1 cycle at 55 $^{\circ}\text{C}$; 2 h at LCT = - 55 $^{\circ}\text{C}$; 1 h/1 kPa at 15 $^{\circ}\text{C}$ to 35 $^{\circ}\text{C}$; 5 cycles at 55 $^{\circ}\text{C}$ $U = (P_{70} \times R)^{1/2}$ $U = U_{\text{max.}}$; whichever is less severe	$\pm (1 \% R + 0.05 \Omega)$	
Endurance at 70 $^{\circ}\text{C}$ (4.25.1)	$U = (P_{70} \times R)^{1/2}$ $U = U_{\text{max.}}$; whichever is less severe 1.5 h on; 0.5 h off; 70 $^{\circ}\text{C}$; 1000 h	$\pm (1 \% R + 0.05 \Omega)$	
Extended endurance (4.25.1.8)	Duration extended to 8000 h	$\pm (2 \% R + 0.1 \Omega)$	
Endurance at upper category temperature (4.25.3)	UCT = 125 $^{\circ}\text{C}$; 1000 h	$\pm (1 \% R + 0.05 \Omega)$	

APPLICABLE SPECIFICATIONS

- | | |
|-----------------|--|
| • EN 60115-1 | Generic Specification |
| • EN 140400 | Sectional Specification |
| • EN 140401-802 | Detail Specification |
| • IEC 60068-2-X | Variety of environmental test procedures |
| • IEC 60286-3 | Packaging of SMD components |



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